

# PATENT ASSIGNMENT

Electronic Version v1.1  
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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT																
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT																
<b>CONVEYING PARTY DATA</b>																	
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<b>CORRESPONDENCE DATA</b>																	
<p>Fax Number: (877)769-7945  <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: (858) 678-5070</p> <p>Email: kzf@fr.com</p> <p>Correspondent Name: Bing Ai</p> <p>Address Line 1: FISH &amp; RICHARDSON P.C.</p> <p>Address Line 2: P.O.BOX 1022</p> <p>Address Line 4: MINNEAPOLIS, MINNESOTA 55440-1022</p>																	

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**PATENT**  
**REEL: 023698 FRAME: 0821**

ATTORNEY DOCKET NUMBER:	25992-0002US1
NAME OF SUBMITTER:	Kelly M. Smith
Total Attachments: 2 source=25992-0002US1Assignment#page1.tif source=25992-0002US1Assignment#page2.tif	

Attorney's Docket No.: \_\_\_\_\_

**Assignment of Application**

WHEREAS, I (WE) \_\_\_\_\_

**Hajime SHIBATA, Hitoshi TAMPO, Koji MATSUBARA, Akimasa YAMADA,****Keiichiro SAKURAI, Shogo ISHIZUKA and Shigeru NIKI** of all \_\_\_\_\_c/o National Institute of Advanced Industrial Science and Technology, Tsukuba Central 2, 1-1,Umezono 1-chome, Tsukuba-shi, Ibaraki 305-8568 Japan, respectively,

have invented certain new and useful improvements in: \_\_\_\_\_

**SEMICONDUCTOR DEVICE**

for which an application for Letters Patent was executed on \_\_\_\_\_

(Application No. **PCT/JP2008/058781**, filed **May 13, 2008**), and

WHEREAS, \_\_\_\_\_

**National Institute of Advanced Industrial Science and Technology**

(hereinafter referred to as "ASSIGNEE") having a place of business at: \_\_\_\_\_

3-1, Kasumigaseki 1-chome, Chiyoda-ku, Tokyo 100-8921 Japan

is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;

NOW, THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is hereby acknowledged, and for other good and valuable consideration, I (WE), by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters Patent which may be granted therefore in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.

I (WE) hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any official of any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my (our) entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me (us) had this Assignment and sale not been made.

Further, I (WE) agree that I (WE) will communicate to said ASSIGNEE or its legal representatives and assigns covenant and any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letter Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

The undersigned hereby grant(s) the firm of **Fish & Richardson P.C.** of 12390 El Camino Real, San Diego, CA 92130 U.S.A. the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: Oct. 22. 2009

Hajime Shibata  
(Signature of inventor) **Hajime SHIBATA**

Date: Oct. 22. 2009

Hitoshi Tampo  
(Signature of inventor) **Hitoshi TAMPO**

Date: Oct. 22. 2009

Koji Matsubara  
(Signature of inventor) **Koji MATSUBARA**

Date: Oct. 22. 2009

Akimasa Yamada  
(Signature of inventor) **Akimasa YAMADA**

Date: Oct. 22. 2009

Keiichiro Sakurai  
(Signature of inventor) **Keiichiro SAKURAI**

Date: OCT. 22. 2009

Shogo Ishizuka  
(Signature of inventor) **Shogo ISHIZUKA**

Date: Nov. 2, 2009

Shigeru Niki  
(Signature of inventor) **Shigeru NIKI**